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*Gueye M.N., Vercouter A., Jouclas R., Guérin D., Lemaur V.,  
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“Thermal conductivity of benzothieno-benzothiophene derivatives at the nanoscale.”

*Nanoscale, 13, 2021, 3800-3807*

**The publisher's version is available at:**

*<https://dx.doi.org/10.1039/d0nr08619c>*

**When citing, please refer to the published version.**

This is the accepted version of the article:

Gueye M.N., Vercouter A., Jouclas R., Guérin D., Lemaury V., Schweicher G., Lenfant S., Antidormi A., Geerts Y., Melis C., Cornil J., Vuillaume D.. Thermal conductivity of benzo-thieno-benzothiophene derivatives at the nanoscale. *Nanoscale*, (2021). 13. : 3800 - . 10.1039/d0nr08619c.

Available at: <https://dx.doi.org/10.1039/d0nr08619c>

# Thermal conductivity of benzothieno-benzothiophene derivatives at the nanoscale

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We study by scanning thermal microscopy the nanoscale thermal conductance of films (40-400 nm thick) of [1]benzothieno[3,2-b][1]benzothiophene (BTBT) and 2,7-dioctyl[1]benzothieno[3,2-b][1]benzothiophene (C8-BTBT-C8). We demonstrate that the out-of-plane thermal conductivity is significant along the interlayer direction, larger for BTBT ( $0.63 \pm 0.12 \text{ W m}^{-1} \text{ K}^{-1}$ ) compared to C8-BTBT-C8 ( $0.25 \pm 0.13 \text{ W m}^{-1} \text{ K}^{-1}$ ). These results are supported by molecular dynamics calculations (Approach to Equilibrium Molecular Dynamics method) performed on the corresponding molecular crystals. The calculations point to significant

thermal conductivity (3D-like) values along the 3 crystalline directions, with anisotropy factors between the crystalline directions below 1.8 for BTBT and below 2.8 for C8-BTBT-C8, in deep contrast with the charge transport properties featuring a two-dimensional character for these materials. In agreement with the experiments, the calculations yield larger values in BTBT compared to C8-BTBT-C8 (0.6-1.3 W m<sup>-1</sup> K<sup>-1</sup> versus 0.3-0.7 W m<sup>-1</sup> K<sup>-1</sup>, respectively). The weak thickness dependence of the nanoscale thermal resistance is in agreement with a simple analytical model.

**Keywords:** *thermal conductivity, scanning thermal microscopy (SThM), approach to equilibrium molecular dynamics (AEMD), organic semiconductor, organic thermoelectricity.*

## INTRODUCTION.

Organic materials have recently attracted a great interest for potential thermoelectric application because commercial modules are built with materials such as bismuth telluride ( $\text{Bi}_2\text{Te}_3$ )-based alloys<sup>1</sup> which are toxic, expensive, and energy-consuming for processing. The candidates range from polymers (like PEDOT:PSS, PEDOT:OTf, and other derivatives) with high electrical conductivity and Seebeck coefficient (up to  $\sim 5,000$ - $6,000 \text{ S cm}^{-1}$  and  $\sim 1 \text{ mV K}^{-1}$ ),<sup>2-5</sup> down to self-assembled monolayers and single molecule junctions (based mainly on alkyl chains, oligo(phenylene ethynylene)s, benzene,  $\text{C}_{60}$ ,...).<sup>6-13</sup> In the latter case, quantum interference effects can be exploited to tailor and optimize the thermoelectric properties of the molecules.<sup>14-17</sup> In contrast to the charge transport properties, the thermal conductivity ( $\mathcal{K}$ ) of thin films of small  $\pi$ -conjugated organic semiconductors (OSCs) appears less studied at both the experimental and theoretical levels. The in-plane  $\mathcal{K}$  of various molecular thin films (pentacene, TPD, Alq3,  $\text{C}_{60}$ , PCBM, rubrene, DNNT, ...) <sup>4, 18-26</sup> has been measured in the range  $0.1 - 0.8 \text{ W m}^{-1} \text{ K}^{-1}$  at the macroscale (ac-calorimetry,  $3\omega$  Joule heating, time domain thermo-reflectance....). Only a very few reports have been published on the out-of-plane  $\mathcal{K}$  of these organic materials at the nanoscale, *e.g.* using the scanning thermal microscope (SThM).<sup>27, 28</sup> On the theoretical side, the prediction of  $\mathcal{K}$  for OSCs and the definition of structure-property relationships is also scarcely addressed. The  $\mathcal{K}$  values can be estimated by models<sup>29</sup> based on: (i) collective excitations of phonons via the resolution of the Boltzmann Transport Equation (BTE); (ii) atomic displacements via Molecular Dynamics (MD) approaches such as the Green-Kubo formalism or the Non Equilibrium Molecular Dynamics method (see below). The BTE approach is known to be far much prohibitive in terms of computational cost than MD-based techniques. Thus,  $\mathcal{K}$  of a few molecules (pentacene,  $\text{C}_{60}$ , PCBM,  $\text{H}_2\text{Pc}$ , TPD,..)<sup>30-38</sup>

have been essentially calculated by various methods belonging to the “MD-class” in order to estimate the anisotropy of  $\mathcal{K}$  along the long axis of the molecules versus in the perpendicular intralayer directions.

In this work, we measure by SThM the out-of-plane  $\mathcal{K}$  at the nanoscale of thin films (40-400 nm thick) of [1]benzothieno[3,2-*b*][1]benzothiophene (BTBT) and 2,7-dioctyl[1]benzothieno[3,2-*b*][1]benzothiophene (C8-BTBT-C8).<sup>39, 40</sup> These molecules have promising performances for organic electronics with reproducible transistor hole mobilities in excess of  $10 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$  and up to  $\sim 200 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$  at the local scale.<sup>40, 41</sup> Since their thermoelectric properties were not investigated experimentally up to now, this has stimulated the present experimental and theoretical works to determine the structure-property relationships of BTBT derivatives, especially the role of alkyl chains on the thermal transport. We demonstrate (SThM) that  $\mathcal{K}_{BTBT} = 0.63 \pm 0.12 \text{ W m}^{-1} \text{ K}^{-1}$  is larger than  $\mathcal{K}_{C8-BTBT-C8} = 0.25 \pm 0.13 \text{ W m}^{-1} \text{ K}^{-1}$ . The nanoscale thermal resistance is weakly dependent on the film thickness, as predicted by a simple analytical model of the constriction thermal resistance for a surface coated by a thin film. The experimental results are supported by the theoretical estimates of  $\mathcal{K}$  obtained by the AEMD (Approach to the Equilibrium Molecular Dynamics) method.<sup>42</sup> We find  $\mathcal{K}$  along the long *c*-axis of the molecules larger for BTBT ( $1.04 \text{ W m}^{-1} \text{ K}^{-1}$ ) than for C8-BTBT-C8 ( $0.72 \text{ W m}^{-1} \text{ K}^{-1}$ ). The results also point to a decrease of  $\mathcal{K}$  in the *a-b* plane upon alkylation (from 0.6-1.3  $\text{W m}^{-1} \text{ K}^{-1}$  for BTBT to 0.26-0.33  $\text{W m}^{-1} \text{ K}^{-1}$  for C8-BTBT-C8).

## RESULTS.

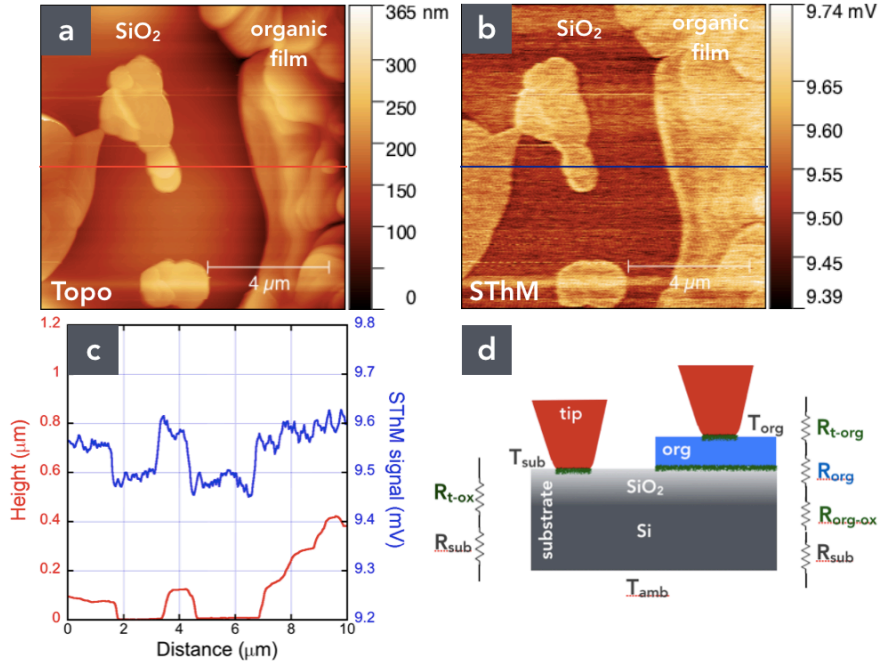
### *Scanning thermal microscopy results.*

Figure 1 shows the typical topographic and thermal voltage images of a C8-BTBT-C8 film prepared by spin-coating (see Methods). The organic thin film has a staircase topography (Fig. 1-a, height profile Fig. 1-c, red curve) with an

incomplete surface coverage leaving apparent several zones of the underlying Si/SiO<sub>2</sub> substrate. The same type of "staircase" topography is observed for all samples (Figs. S1 and S2 in the ESI), in agreement with previous results.<sup>43</sup> In contrast, the SThM thermal voltage (Fig. 1-b) shows a featureless structure (Fig. 1-c, blue curve) for all samples (Figs. S1 and S2 in the ESI). The thermal voltage  $V_{SThM}$  is related to the thermal resistance of the sample by:

$$V_{SThM} \propto (T_{sample} - T_{amb}) \propto R_{th} \dot{Q} \quad (1)$$

where  $T_{sample}$  is the temperature of the surface sample,  $T_{amb}$  the ambient temperature,  $R_{th}$  the thermal resistance of the sample and  $\dot{Q}$  the thermal flux. We analyzed the SThM image to determine the thermal resistance of the films at various locations with various thicknesses  $t$ , taking the thermal resistance of the Si/SiO<sub>2</sub> substrate as a reference (Fig. 1-d).

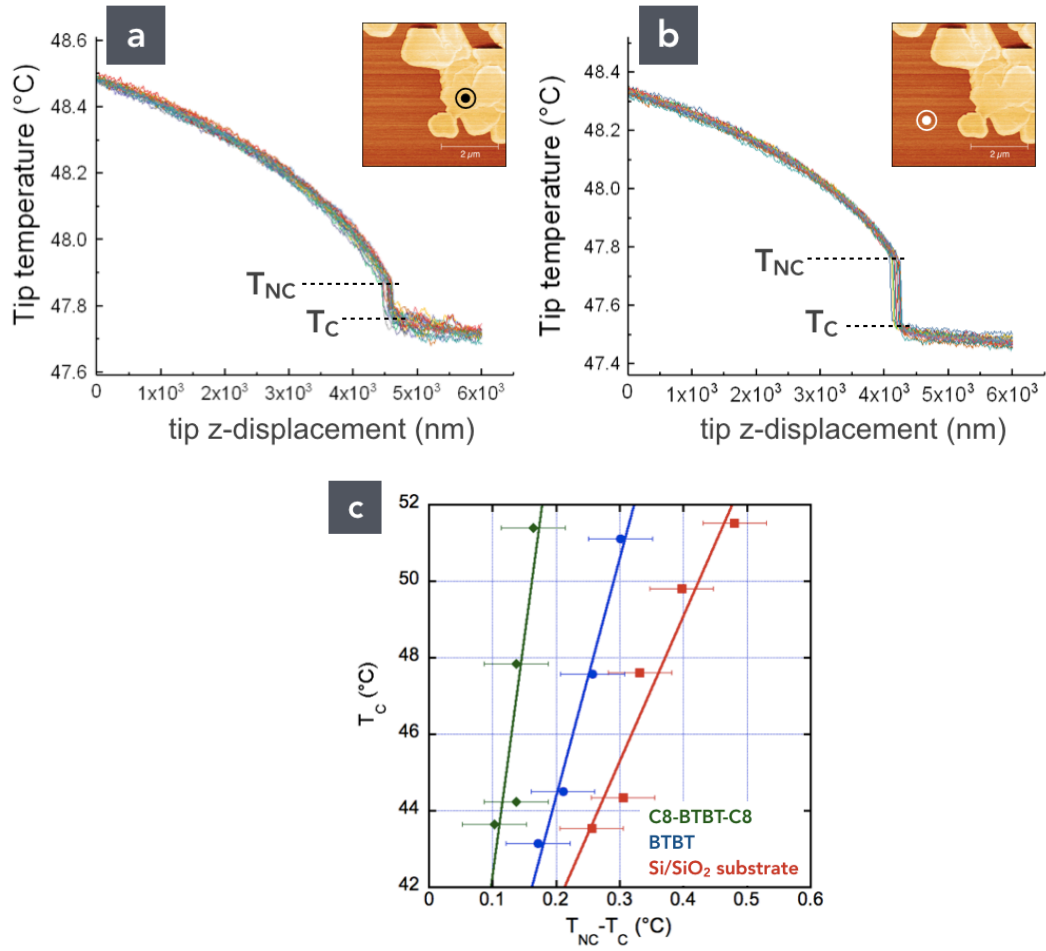


**Figure 1.** (a) Topographic (10  $\mu\text{m} \times 10 \mu\text{m}$ ) and (b) SThM thermal voltage (at the output of the Wheatstone bridge,  $3\omega$ -SThM method) images of a C8-BTBT-C8 film

spin-coated on Si/SiO<sub>2</sub> substrate, **(c)** height (red) and thermal voltage profiles (blue). **(d)** Schematic of the nanoscale SThM measurement. On the substrate, the thermal resistance is  $R_{th-ox}=R_{t-ox}+R_{sub}$ , with  $R_{t-ox}$  the thermal resistance of the tip-SiO<sub>2</sub> interface and  $R_{sub}$  the thermal resistance of the substrate. Over the organic domains, we have  $R_{th-org}=R_{t-org}+R_{org}(t)+R_{org-ox}+R_{sub}$ , with  $R_{t-org}$  the thermal resistance of the tip-organic interface,  $R_{org}(t)$  the thermal resistance of the organic film of thickness  $t$  and  $R_{org-ox}$  the thermal resistance of the organic-oxide interface (Fig. 1-d).

We determined  $K$  using the null-point method, NP-SThM.<sup>44</sup> This differential method is suitable to remove the parasitic contributions (air conduction, etc...). When the tip contacts the sample surface (C), both the sample and parasitic thermal contributions are involved, whereas, just before physical tip contact (non contact, NC), only the parasitic thermal contributions are involved. We measured the thermal voltage  $V_{SThM-z}$  traces at several places on the organic films and on the substrate zones. The tip temperature is determined from  $V_{SThM}$  (see the ESI). Figure 2 show 25 typical tip temperature versus distance (z-trace) curves measured on the C8-BTBT-C8 domain and on the nearby apparent Si/SiO<sub>2</sub> substrate (circled bullets on the SThM images in the insets). When approaching the heated tip to the surface, the tip temperature decreases gradually because the heat transfer through the air gap is increased. At contact, we observe a sudden decrease from  $T_{NC}$  to  $T_C$ , due to the additional heat flux through the tip-sample contact. Figure 2-c shows the  $T_C$  versus  $T_{NC}-T_C$  curves for the C8-BTBT-C8 and BTBT samples and on the apparent substrate zone, where  $T_C$  and  $T_{NC}$  are the measured temperature at contact and non-contact conditions.





**Figure 2.** 25 tip temperature versus *tip vertical displacement* curves (*z*-trace, approach, 0 corresponds to the tip retracted) measured at  $V_{DC} = 0.6$  V on **(a)** a C8-BTBT-C8 domain (sample #5), **(b)** on the Si/SiO<sub>2</sub> substrate (as indicated by the circled bullets). **(c)** Temperature jump  $T_{NC} - T_C$  versus temperature at tip contact  $T_C$  for C8-BTBT-C8 (◆), BTBT (●) and the Si/SiO<sub>2</sub> substrate (■). The increasing  $T_C$  corresponds to a supply voltage  $V_{DC}$  from 0.6 - 0.9 V (by step of 0.1 V) of the Wheatstone bridge (0.6 - 1 V, step of 0.1 V on the substrate). Solid lines are the linear fits. Each data point (C8-BTBT-C8 and BTBT) is the average of 3 measurements at 3 different locations (25  $V_{STHM}$ - $z$  traces at each location). The data points for the substrate are averaged from the data acquired on the 2 samples.

The thermal conductivity is determined using the following relation:<sup>44</sup>

$$T_C - T_{amb} = \left[ \alpha \frac{1}{\kappa} + \beta \right] (T_{NC} - T_C) \quad (2)$$

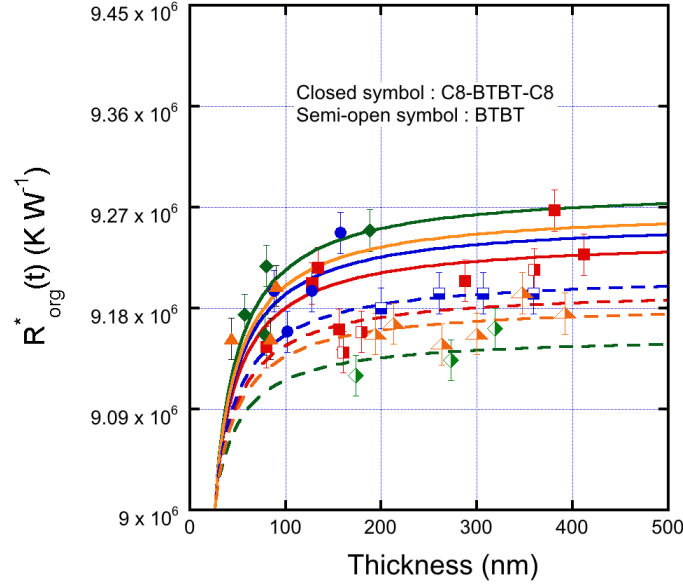
where  $\alpha$  and  $\beta$  are calibrated parameters related to the SThM equipment and tip (Fig. S3 in the ESI) and  $T_{amb}$  the room temperature ( $\alpha = 25.6 \text{ W/m.K}$ ,  $\beta = 21.6 \text{ K/K}$  and  $T_{amb} = 22.5 \text{ }^\circ\text{C}$ ). From a linear fit on these data, we get:  $\kappa_{C8-BTBT-C8} = 0.25 \pm 0.13 \text{ W m}^{-1} \text{ K}^{-1}$ ,  $\kappa_{BTBT} = 0.63 \pm 0.12 \text{ W m}^{-1} \text{ K}^{-1}$  and  $\kappa_{sub} = 1.57 \pm 0.43 \text{ W m}^{-1} \text{ K}^{-1}$ . A key finding is that the thermal conductivity of BTBT is larger than that of C8-BTBT-C8, in full consistency with our AEMD simulations (see below). For the Si/SiO<sub>2</sub> substrate, we found a value close to that of bulk SiO<sub>2</sub>, in agreement with previous measurements by NP-SThM<sup>44</sup> showing that the effective  $\kappa$  is that of bulk SiO<sub>2</sub> (see Fig. 6-b in Ref. 44 and Fig. S4) if the SiO<sub>2</sub> thickness is larger than  $\sim 100 \text{ nm}$  (here 200-500 nm).

The ratio of the thermal voltage measured on the organic domain over that on the substrate (Fig. 1),  $V_{SThM-org}/V_{SThM-sub}$  is related to the ratio of the corresponding thermal resistance of each zone. For the Si/SiO<sub>2</sub> substrate, the constriction thermal resistance<sup>45</sup> is  $R_{sub} = 1/4r\kappa_{OX} = 9 \times 10^6 \text{ K W}^{-1}$  with  $\kappa_{OX}$  the "bulk" SiO<sub>2</sub> value ( $1.4 \text{ W m}^{-1} \text{ K}^{-1}$ ) and  $r$  is the radius of the SThM tip thermal contact (estimated to be  $\approx 20 \text{ nm}$ , see the ESI). In order to determine the  $R_{org}(t)$  from this SThM voltage ratio, we need to estimate the various interfacial resistances (Kapitza resistance)<sup>46</sup> which cannot be directly measured here. Reported values for a large variety of interfaces<sup>27, 47-54</sup> range typically between  $10^{-9}$  and  $10^{-6} \text{ m}^2 \text{ K W}^{-1}$ . For simplicity, we consider the lower limit value for all interfaces. In that case, the interface thermal resistances are negligible ( $8 \times 10^5 \text{ K W}^{-1}$ ) compared to  $R_{sub}$  and  $R_{org}$  ( $R_{sub} = 1/4r\kappa_{OX} = 9 \times 10^6 \text{ K W}^{-1}$ ,  $R_{org} = 1/4r\kappa_{org} =$

2-5x10<sup>7</sup> K W<sup>-1</sup>, considering the values of  $\kappa_{org}$  determined above). In this oversimplified case, the ratio of the thermal voltage measured on the organic domain versus over the substrate is given by  $V_{SThM-org}/V_{SThM-sub} = R_{org}^*(t)/R_{sub}$ , assuming the same thermal flux  $\dot{Q}$  on the oxide and the organic domain (see the ESI), where  $R_{org}^*(t)$  is the effective constriction thermal resistance measured by the sharp SThM tip at the surface of the organic thin film. We consider a simple analytical model derived by Dryden<sup>55</sup> for film with  $t/r > 2$  (here  $t > 40$  nm):

$$R_{org}^*(t) = \frac{1}{4r\kappa_{org}} - \frac{1}{2\pi r\kappa_{org}} \left( \frac{r}{t} \right) \ln \left( \frac{2}{1 + \kappa_{org}/\kappa_{sub}} \right) \quad (3)$$

The first term on the right-hand side stands for the constriction thermal resistance of the bulk organic film ( $t \rightarrow \infty$ ) and the second term represents the effect of the underlying substrate covered by the film of thickness  $t$ . Figure 3 shows the measured  $R_{org}^*(t)$  obtained from  $V_{SThM-org}/V_{SThM-sub}$  ratios picked up at various locations on the organic films with various thicknesses (Fig. 1, Figs. S1 and S2, in the ESI) and on the underlying substrate, taking  $R_{sub} = 1/4r\kappa_{OX} = 9 \times 10^6$  K W<sup>-1</sup>.



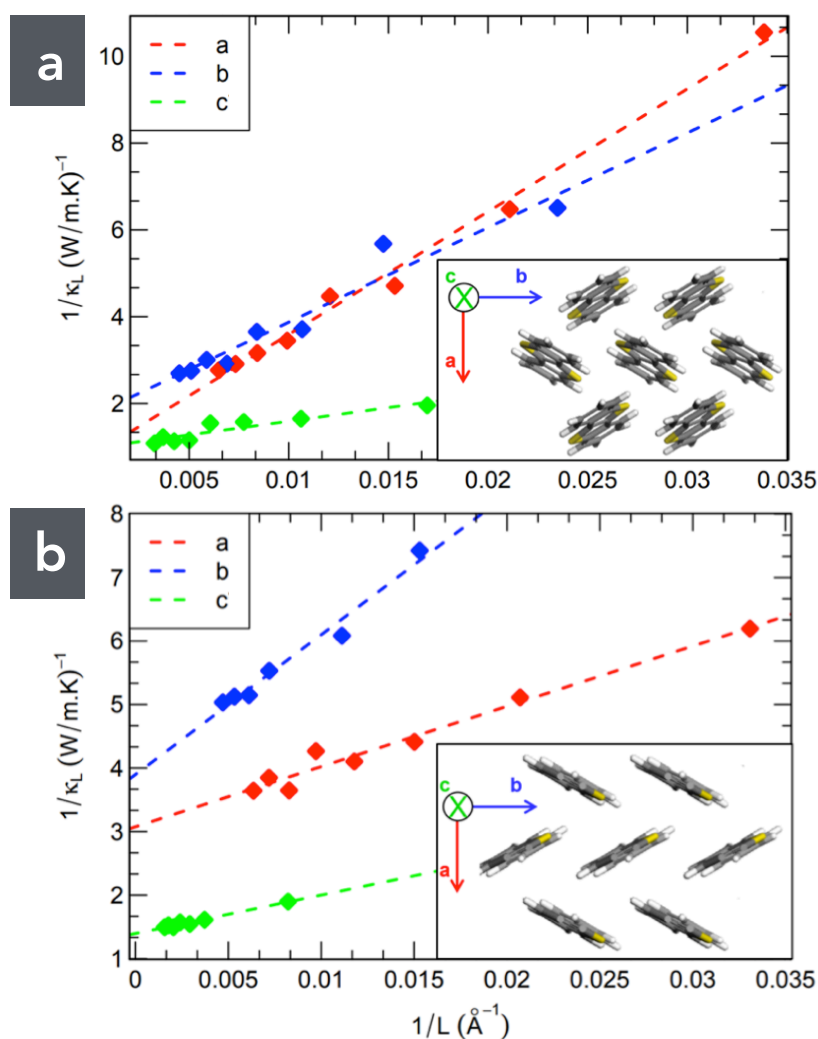
**Figure 3.** Effective constriction thermal resistance  $R_{org}^*(t)$  measured at the surface of the organic film for the C8-BTBT-C8 samples (closed symbols) and for the BTBT samples (semi-open symbols). Data and fit (lines): red = sample #1, blue = sample #2, green = sample #3, and orange = sample #4 as defined in the ESI.

For  $t \rightarrow \infty$ ,  $R_{org}^*(t)$  tends to saturate at a larger value for C8-BTBT-C8 than for BTBT although the difference is weak. This trend is in agreement with the NP-SThM determination that  $K_{BTBT} > K_{C8-BTBT-C8}$ . From the fits of Eq. 3 (solid lines in Fig. 4), we obtain a mean value (see the ESI)  $K_{BTBT} = 1.37 \pm 0.01 \text{ W m}^{-1} \text{ K}^{-1}$  and  $K_{C8-BTBT-C8} = 1.35 \pm 0.01 \text{ W m}^{-1} \text{ K}^{-1}$  which are not significantly different. This implies that, even though the same trends are observed as with the NP-SThM method, this image analysis approach is perturbed by the interfacial thermal resistance, which more or less masks the actual values of the organic film thermal resistance. Previous works<sup>27, 28, 49, 50, 54</sup> also reported SThM tip-organic materials and organic-SiO<sub>2</sub> interfacial thermal resistances larger than  $10^7 \text{ K W}^{-1}$  (or  $> \sim 10^{-8} \text{ m}^2 \text{ K W}^{-1}$ ), *i.e.*, larger than  $R_{org}$  of our C8-BTBT-C8 and BTBT films.

### **Theory.**

We use the Approach to the Equilibrium Molecular Dynamics (AEMD) method<sup>42</sup> to compute the lattice  $\mathcal{K}$ . We ignored the contribution of the electronic  $\mathcal{K}$  at this stage because the thermal transport is barely controlled by electrons in most neutral and weakly doped organic semiconductors (OSCs).<sup>56</sup> This argument is supported by the newly developed molecular Wiedemann-Franz model<sup>57</sup> which predicts an electronic contribution to the heat transport smaller by several orders of magnitude than the corresponding lattice contribution. In brief, the key steps of the AEMD methodology are the following: (i) applying a perfectly monitored thermal pulse on a simulation box; (ii) recovering the initial thermodynamic equilibrium during a fast transient regime; (iii) fitting the time-decaying temperature difference between the right and left parts of the system from a reliable solution of the one-dimensional heat equation  $\frac{\partial T}{\partial t} = D \frac{\partial^2 T}{\partial x^2}$  in order to

evaluate the thermal diffusivity,  $D$ .<sup>58</sup> This alternative scheme has the benefit to be far less time-consuming than the previously cited methods due to the rapid dissipation of the thermal gradient. Then  $\mathcal{K} = D\rho C_p$  is finally obtained, provided the density,  $\rho$ , and the specific heat,  $C_p$ , of the system are known (see details in the ESI). It is also of prime importance to account for the size-dependence of the  $\mathcal{K}$  values deduced from this approach since phonons having a mean free path larger than the cell dimension do not effectively contribute to  $\mathcal{K}$ . An extrapolation procedure is thus needed to get rid of these size effects<sup>59</sup> and to extract a quasi-length-free lattice  $\mathcal{K}$  from the linear regression of  $1/\mathcal{K}$  versus  $1/L$  ( $L$  the length of the box size along the direction of heat propagation).



**Figure 4.** Inverse of the lattice thermal conductivity as a function of the inverse of the simulation box length along directions *a*, *b* and *c* for **(a)** BTBT and **(b)** C8-BTBT-C8. Each inset represents the molecular packing of BTBT and C8-BTBT-C8 in the *ab* plane. For sake of clarity, we did not represent the alkyl chains in (b). The two compounds crystallize into a monoclinic structure ( $a = 5.854 \text{ \AA}$ ,  $b = 7.960 \text{ \AA}$ ,  $c = 11.809 \text{ \AA}$ ,  $\alpha = 105.990^\circ$  for BTBT and  $a = 5.927 \text{ \AA}$ ,  $b = 7.880 \text{ \AA}$ ,  $c = 29.180 \text{ \AA}$ ,  $\beta = 92.443^\circ$  for C8-BTBT-C8; respectively); both of them exhibit a very similar layered herringbone packing,<sup>60</sup> as shown in the insets.

Figure 4 display the inverse of the calculated lattice  $\mathcal{K}$  as a function of the inverse of the super cell length. The linear extrapolation procedure provides  $\mathcal{K}$  values of 1.31, 0.59 and 1.04  $\text{W m}^{-1} \text{K}^{-1}$  along directions a, b and c for BTBT and 0.33, 0.26 and 0.72  $\text{W m}^{-1} \text{K}^{-1}$  along the same directions for C8-BTBT-C8 (Table 1). There is a fairly good quantitative agreement between experimental measurements and theoretical estimates. Interestingly, the calculations indicate that the overall calculated conductivity (along the 3 crystal axes) of BTBT is higher than for C8-BTBT-C8 (Table 1), in full consistency with the experimental measurements probing essentially heat transport along the c axis.

Theory	BTBT	C8-BTBT-C8
a-axis	1.31	0.33
b-axis	0.59	0.26
c-axis	1.04	0.72
isotropic approximation	0.95	0.46
Experiment		
null-point SThM	$0.63 \pm 0.12$	$0.25 \pm 0.13$

**Table 1.** Calculated and measured thermal conductivity values ( $\text{W m}^{-1} \text{K}^{-1}$ )

## DISCUSSION.

Since no theoretical and experimental data of the out-of-plane  $\mathcal{K}$  was previously reported for these BTBT derivatives, we compare our values with other results obtained for various OSCs. The measured nanoscale out-of-plane  $\mathcal{K}_{\text{C8-BTBT-C8}} = 0.25 \pm 0.13 \text{ W m}^{-1} \text{K}^{-1}$ , is on par with values reported for other small molecule thin films by SThM: 0.15-0.20  $\text{W m}^{-1} \text{K}^{-1}$  for methylstyryl-benzene,<sup>28</sup> 0.15-0.4  $\text{W m}^{-1} \text{K}^{-1}$  for CuPc (Cu-phthalocyanine) and 0.15-0.25  $\text{W m}^{-1} \text{K}^{-1}$  for PbCu.<sup>27</sup> They are also consistent with the corresponding values obtained by characterization methods

at the macroscale on rubrene ( $0.07 \text{ W m}^{-1} \text{ K}^{-1}$ )<sup>23</sup> and DNTT ( $0.45 \text{ W m}^{-1} \text{ K}^{-1}$ ).<sup>24</sup> The experimental out-of-plane  $\kappa_{\text{BTBT}} = 0.63 \pm 0.12 \text{ W m}^{-1} \text{ K}^{-1}$  lies at the highest limit of reported values:  $0.45 \text{ W m}^{-1} \text{ K}^{-1}$  for DNTT<sup>24</sup> (to the best of our knowledge and excluding the highly unusual value of  $21 \text{ W m}^{-1} \text{ K}^{-1}$  reported for crystal of TIPS-pentacene<sup>61, 62</sup>).

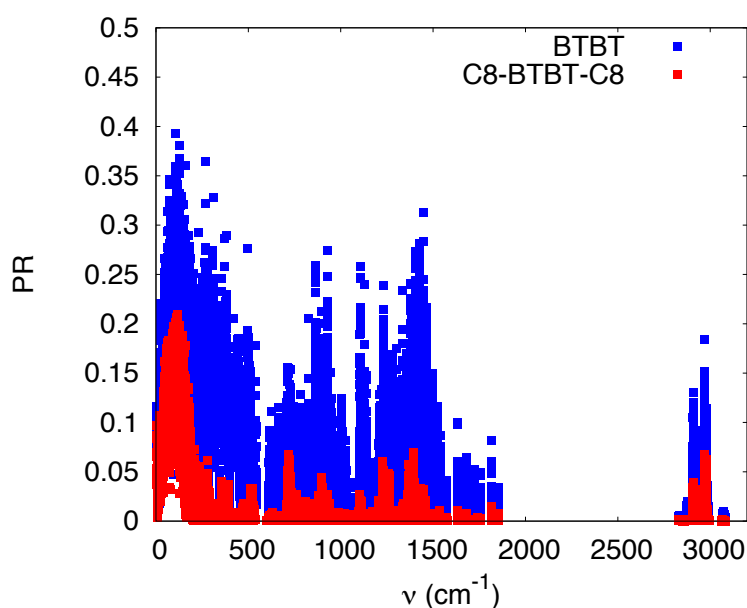
The calculations of the lattice  $\kappa$  were performed on single crystals while the SThM measurement was carried out on polycrystalline samples containing a certain amount of disorder. It is also known (X-ray diffraction) that a disordered layer of less than *ca.* 10 nm exists at the  $\text{SiO}_2/\text{BTBT}$  interfaces.<sup>39</sup> To cope with this "experimental" disorder we compare the measured values with an effective isotropic  $\kappa_{\text{eff}}$  defined as<sup>63</sup>  $\kappa_{\text{eff}} = \sqrt{\kappa_c \kappa_{ab}}$  where the in-plane  $\kappa$  is  $\kappa_{ab} = \sqrt{\kappa_a \kappa_b}$ . The calculated values are given in Table 1. A ratio of 2-2.5 between the thermal conductivities of BTBT and C8-BTBT-C8 is observed at both the experimental and theoretical level. **For both materials, the agreement between the evaluated  $\kappa_{\text{eff}}$  and the measurements (Table 1) is excellent, supporting the existence of a thin disordered layer at the  $\text{SiO}_2/\text{BTBT}$  interface with a lower thermal conductivity (*i.e.* ab-plane).**

We do find a rather isotropic (3D) behavior of the heat propagation in the two derivatives in deep contrast with the charge transport properties featuring a two-dimensional character in presence of a herringbone arrangement;<sup>60, 64, 65</sup> note that a significant thermal conductivity along the three crystalline axes has also been reported theoretically for the DNTT single crystal<sup>36</sup>. The  $\kappa$  ratios for a/b, c/a and c/b are respectively 2.22, 0.79 and 1.76 for BTBT and 1.27, 2.18 and 2.77 for C8-BTBT-C8. Moreover, we evidence a noticeable drop in the ab-plane  $\kappa$  when octyl chains are added on each side of the aromatic cores, with anisotropic factors of  $\kappa_{a^*}^{\text{C0}} / \kappa_{a^*}^{\text{C8}} \sim 3.97$  and  $\kappa_{b^*}^{\text{C0}} / \kappa_{b^*}^{\text{C8}} \sim 2.27$ . This complements the theoretical



study of Shi et al.<sup>32</sup> showing that  $\kappa$  is marginally affected by the presence of terminal saturated chains in C<sub>n</sub>-BTBT-C<sub>n</sub> (with  $n = 8;10;12$ ). It is worth stressing that the drop in thermal conductivity upon addition of saturated chains has been also clearly observed in recent  $\kappa$  measurements performed on DNTT and C8-DNTT-C8 thin films in the a-b plane, and fully supported again by our AEMD calculations.<sup>66</sup>

To gain a deeper insight into the underlying physical mechanisms, we explore the spatial character of the vibrational modes, by estimating their participation ratio (PR).<sup>67</sup> This parameter is a quantitative measure of the spatial extension of vibrations, allowing to classify them into extended (large PR) and localized modes (PR  $\sim 0$ ). It has been shown<sup>68</sup> that extended modes are generally more effective in transporting heat across the material than localized modes. The details of the calculations are given in the ESI.



**Figure 5.** Estimated Participation Ratio (PR) as a function of the vibrational frequency for BTBT (blue) and C8-BTBT-C8 (red).

The participation ratio of vibrations in BTBT and C8-BTBT-C8 are shown in Fig. 5 as a function of their frequency. We observe that PR in BTBT takes larger values than C8-BTBT-C8 over the whole frequency spectrum. This shows that BTBT hosts vibrational modes are spatially more extended than those in C8-BTBT-C8. Hence, BTBT alkylation leads to a strong localization of the vibrational modes and consequently to a strong reduction of the overall thermal conductivity.

## CONCLUSION.

In summary, we demonstrate that the thermal conductivity of BTBT,  $k_{\text{BTBT}} = 0.63 \pm 0.12 \text{ W m}^{-1} \text{ K}^{-1}$  is larger than for C8-BTBT-C8,  $k_{\text{C8-BTBT-C8}} = 0.25 \pm 0.13 \text{ W m}^{-1} \text{ K}^{-1}$ . The nanoscale thermal resistance is weakly dependent on the film thickness, as predicted by a simple analytical model of the constriction thermal resistance for a surface coated by a thin film. The experimental results are further supported by the theoretical estimates of the thermal conductivity obtained by the AEMD (Approach to the Equilibrium Molecular Dynamics) method. Moreover, we have not only demonstrated the drop of the thermal conductivity upon introduction of saturated chains but we have also provided a clear rationale based on the degree of delocalization of the intermolecular vibrational modes. Finally, our calculations point to significant thermal conductivity (3D-like) values along the 3 crystalline directions, with anisotropy factors between the crystalline directions below 1.8 for BTBT and below 2.8 for C8-BTBT-C8, in deep contrast with the charge transport properties featuring a two-dimensional character for these materials.

## METHODS.

**Synthesis and sample fabrication.** BTBT and C8-BTBT-C8 were synthesized according to the reported procedures.<sup>69, 70</sup> The thin films were deposited by spin-

coating on thermal SiO<sub>2</sub>/Si-n<sup>+</sup> according to previously reported methods.<sup>39, 43</sup> Nine samples (5 C8-BTBT-C8, 4 BTBT) were prepared using various spin-coating parameters to vary the film thickness (see the ESI).

**Scanning Thermal Microscope (SThM).** SThM<sup>71, 72</sup> were carried out with a Bruker ICON machine equipped with the Anasys SThM module. All measurements were done at room temperature in an air-conditioned laboratory ( $T_{\text{amb}} = 22.5$  °C, relative humidity of 35-40 %). In the scanning mode, the topography and thermal voltage were recorded simultaneously. We used both the DC method or the 3 $\omega$ -SThM.<sup>73</sup> The thermal conductivity is determined by using the null-point SThM method (see the ESI).<sup>44</sup>

**Calculations of the lattice thermal conductivity.** All MD simulations have been performed in the LAMMPS software package<sup>74</sup> by means of the Optimized Potentials for Liquid Simulations All-Atoms (OPLS-AA) force-field (see the ESI). In addition, we also estimated the participation ratio to characterize the vibrational properties of both BTBT and C8-BTBT-C8. This parameter is a quantitative measure of the spatial extension of vibrations (see the ESI).

## ASSOCIATED CONTENT

Electronic Supplementary Information (ESI) is available:

Sample fabrication, SThM methods, theoretical methods, additional SThM images, NP-SThM calibration, estimation of the constriction thermal resistance of the Si/SiO<sub>2</sub> substrate, estimation of the radius of the thermal contact between tip and surface, fitted parameters of Eq. 3.

## AUTHOR CONTRIBUTIONS

M.N.G. prepared the samples, carried out and analyzed the SThM measurements with the help of D.G. and S.L., respectively. A.V. carried out the calculations of the thermal conductivity under the supervision of V.L. and J.C.. R.J., G.S. and Y.G. synthesized and assessed purity of the materials. A.A. and C.M. carried out the

calculations of the vibrational properties. D.V. conducted the project, analyzed the results and wrote the paper with the help of all the authors. All authors have given approval to the final version of the manuscript.

# These authors (M.N.G. and A.V.) contributed equally to this work.

## **CONFLICTS OF INTEREST.**

The authors declare no competing financial interest.

## **ACKNOWLEDGEMENTS.**

M.G., D.G., S.L. and D.V. thank the ANR for financial support (ANR-16-CE05-0029). Y.G. is thankful to the Belgian National Fund for Scientific Research (FNRS) for financial support through research projects BTBT (# 2.4565.11), Phasetrans (# T. 0058.14), Pi-Fast (# T.0072.18), 2D to 3D (# 30489208), and DIFFRA (# U.G001.19). Financial supports from the French Community of Belgian (ARC # 20061) is also acknowledged. G.S. acknowledges postdoctoral fellowship support from the FNRS. The work in the Laboratory for Chemistry of Novel Materials was supported by the Consortium des Équipements de Calcul Intensif (CÉCI), funded by the Fonds de la Recherche Scientifique de Belgique (F.R.S.-FNRS) under Grant # 2.5020.11. J.C. and A.V. are FNRS research fellows.

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